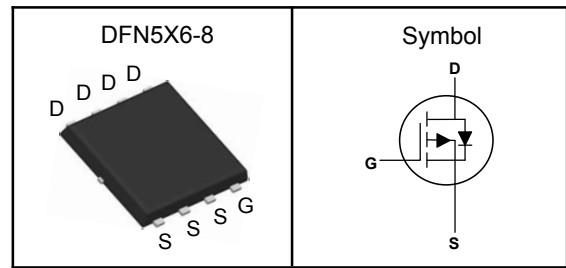


P-Channel Enhancement Mode MOSFET
Features

- Low $R_{ds(on)}$ for low conduction loss
- Reliable and Rugged
- ROHS Compliant & Halogen-Free

Applications

- Power Management in Desktop Computer
- DC/DC Converters

Pin Description


V_{bss}	-60	V
$R_{ds(ON)-Typ}$	10	$m\Omega$
I_D	-60	A

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$, Unless Otherwise Noted)

Symbol	Parameter	P-Channel	Unit
V_{bss}	Drain-Source Voltage	-60	V
V_{GSS}	Gate-Source Voltage	± 25	V
T_J	Maximum Junction Temperature	-55 to 150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$I_{DM}^{①}$	Pulse Drain Current Tested	$T_C=25^\circ\text{C}$	-300 A
I_D	Continuous Drain Current	$T_C=25^\circ\text{C}$	-60 A
P_D	Maximum Power Dissipation	$T_C=25^\circ\text{C}$	89.3 W
EAS	Single Pulse Avalanche Energy	$L=0.5\text{mH}$	196 mJ

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}^{③}$	Thermal Resistance-Junction to Ambient Steady State	55	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance Junction-Case Steady State	1.4	$^\circ\text{C}/\text{W}$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C .

Note ③ : Surface Mounted on 1in^2 FR-4 board with 1oz.



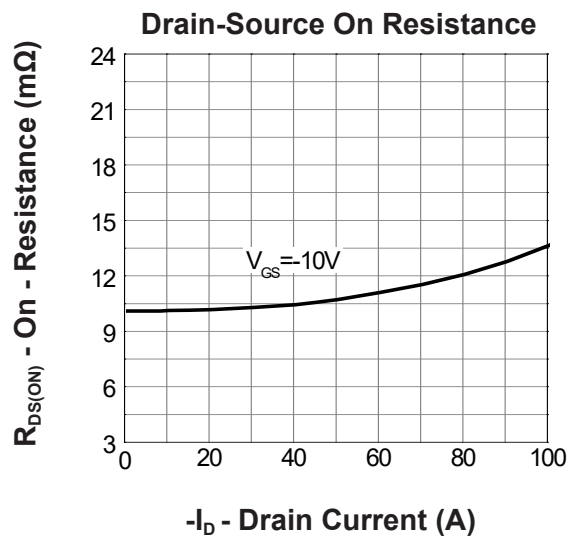
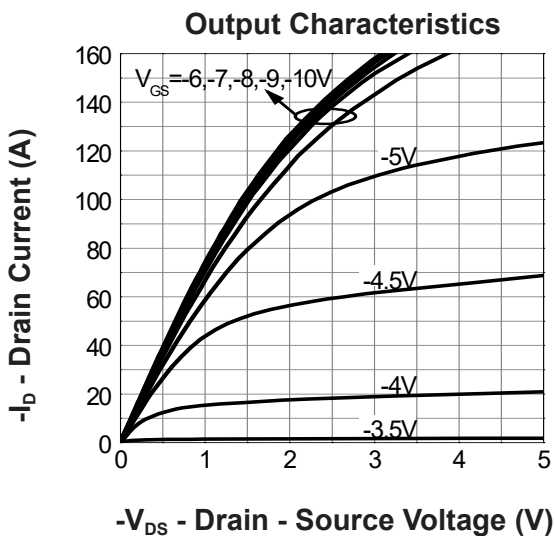
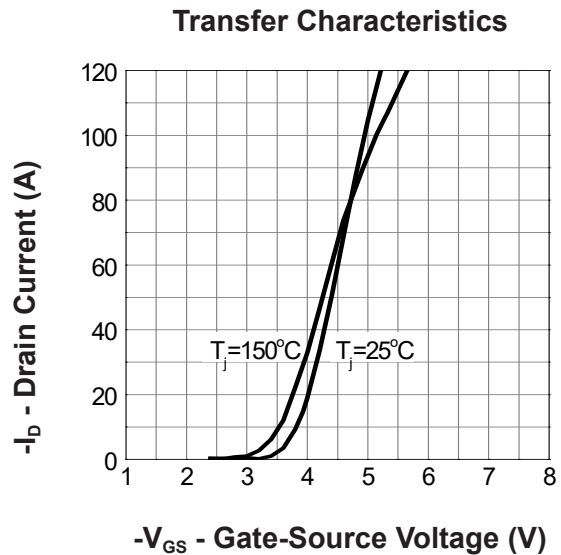
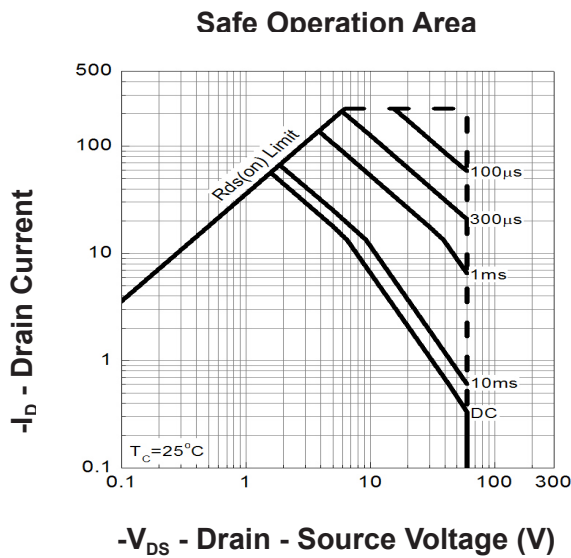
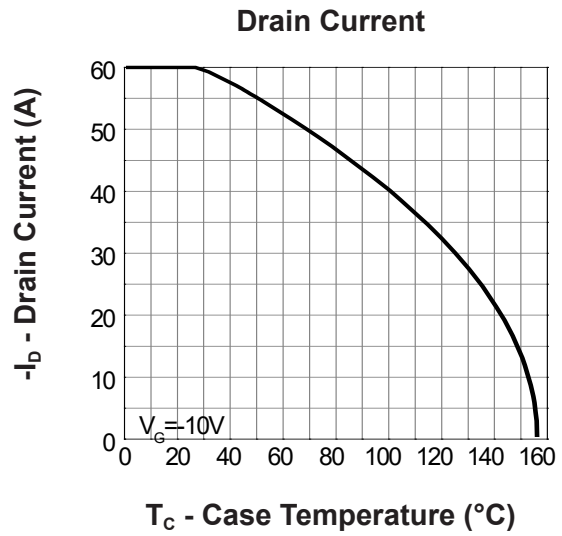
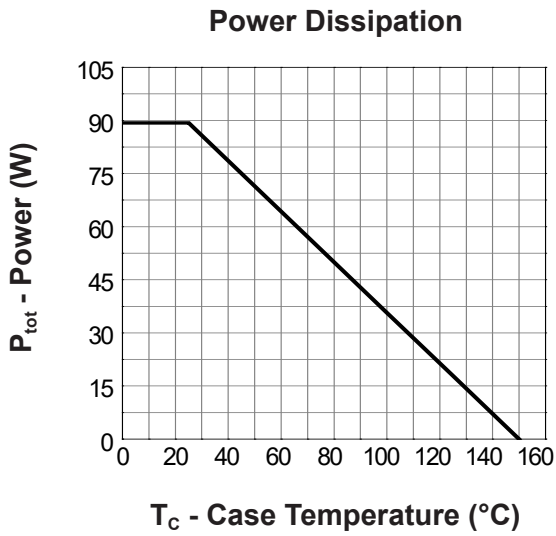
P-Channel Enhancement Mode MOSFET

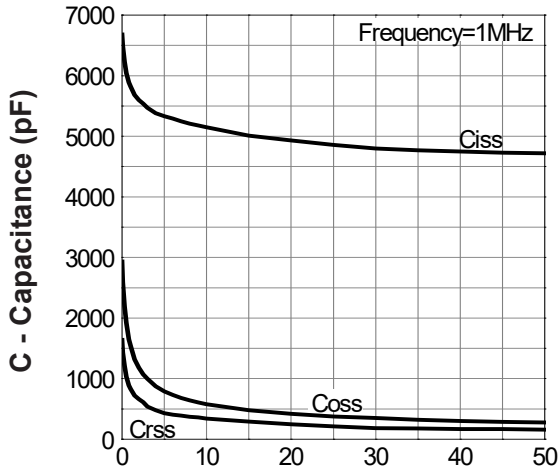
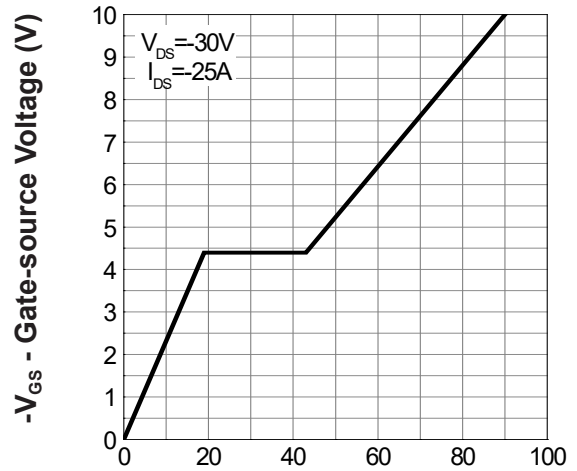
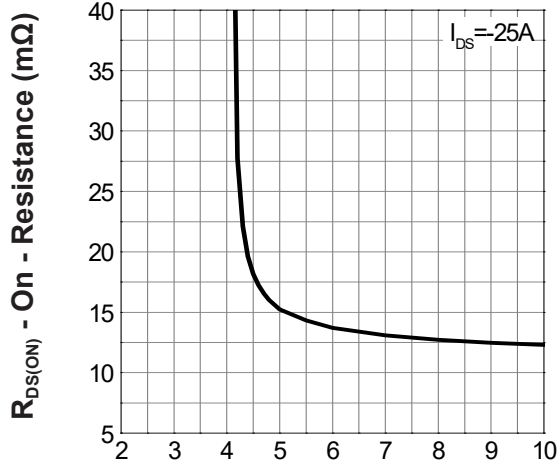
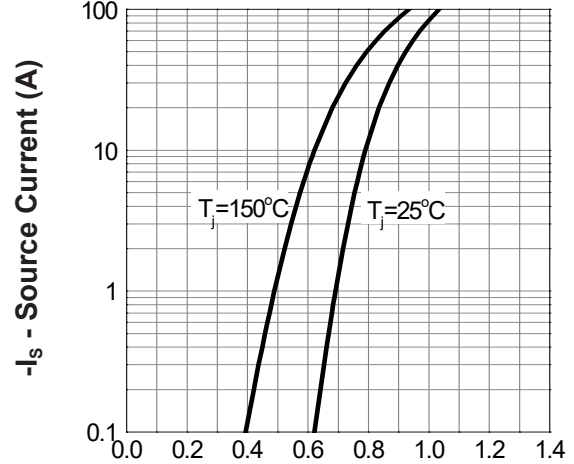
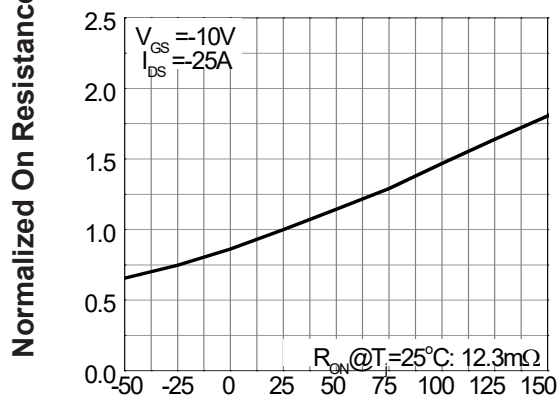
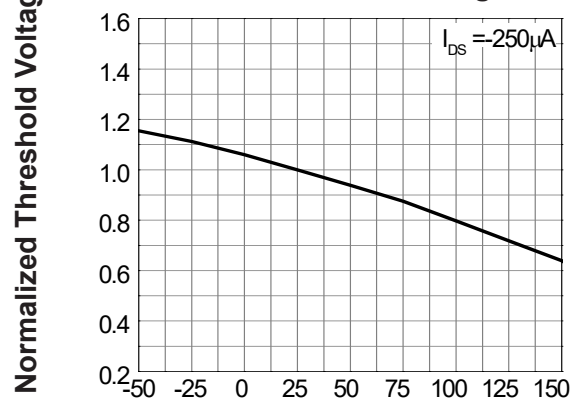
Electrical Characteristics ($T_J=25^{\circ}\text{C}$, Unless Otherwise Noted)

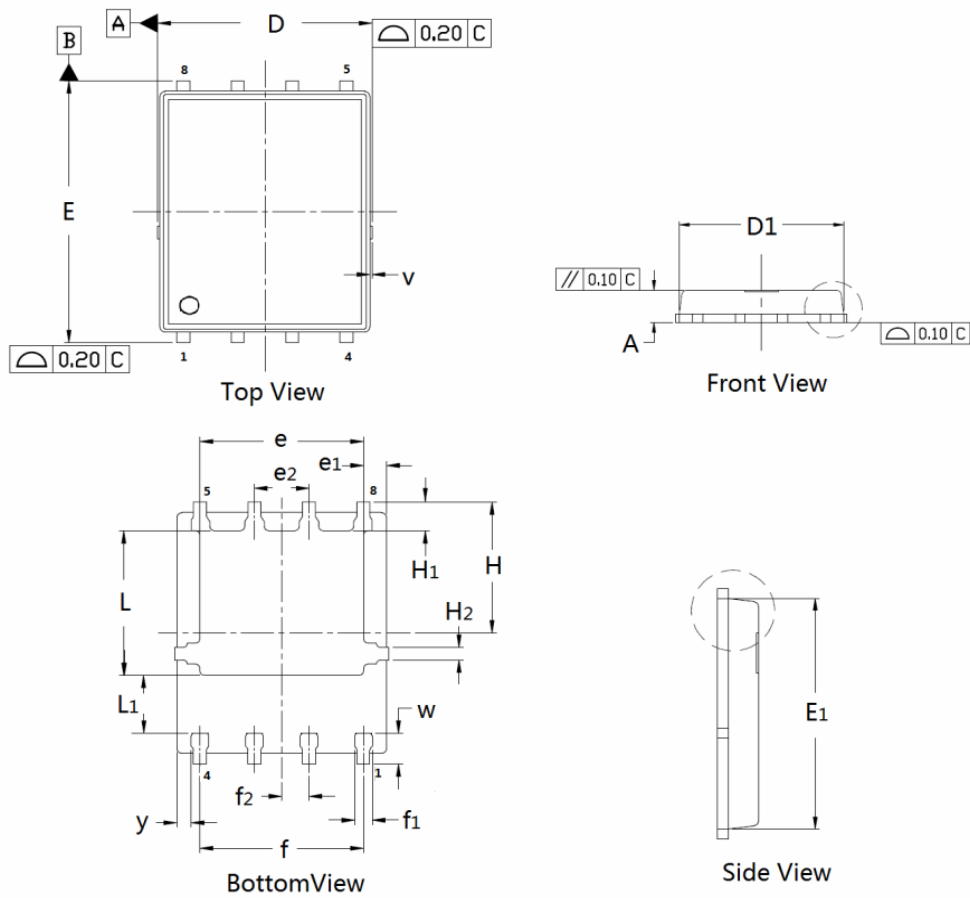
Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-60	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=-48V, V_{GS}=0V$	---	---	-1	μA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1.1	---	-2.5	V
I_{GSS}	Gate Leakage Current	$V_{GS}=\pm 25V, V_{DS}=0V$	---	---	± 100	nA
$R_{DS(ON)}$	Drain-Source On-state Resistance	$V_{GS}=-10V, I_D=-25A$	---	10	14	$m\Omega$
		$V_{GS}=-4.5V, I_D=-25A$	---	11	15	$m\Omega$
Dynamic Characteristics^⑤						
C_{iss}	Input Capacitance	$V_{GS}=0V, V_{DS}=-30V, \text{Freq.}=1\text{MHz}$	---	4800	---	pF
C_{oss}	Output Capacitance		---	350	---	
C_{rss}	Reverse Transfer Capacitance		---	185	---	
$T_{d(on)}$	Turn-on Delay Time	$V_{DD}=-30V, V_{GS}=-10V, R_G=6\Omega, I_D=-1A, R_L=30\Omega$	---	23	---	nS
T_r	Turn-on Rise Time		---	18	---	
$T_{d(off)}$	Turn-off Delay Time		---	115	---	
T_f	Turn-off Fall Time		---	47	---	
Q_g	Total Gate Charge	$V_{DS}=-30V, V_{GS}=-10V, I_D=-25A$	---	90	---	nC
Q_{gs}	Gate-Source Charge		---	19	---	
Q_{gd}	Gate-Drain Charge		---	24	---	
Source-Drain Characteristics ($T_J=25^{\circ}\text{C}$)						
$V_{SD}^{④}$	Diode Forward Voltage	$V_{GS}=0V, I_S=-12A, T_J=25^{\circ}\text{C}$	---	-0.8	-1.1	V
t_{rr}	Reverse Recovery Time	$I_{SD}=-25A, di/dt=100A/\mu s, T_J=25^{\circ}\text{C}$	---	39	---	nS
Q_{rr}	Reverse Recovery Charge		---	62	---	nC

Note ④: Pulse test (pulse width 300us, duty cycle 2%).

Note ⑤: Guaranteed by design, not subject to production testing.

P-Channel Enhancement Mode MOSFET
Typical Characteristics


P-Channel Enhancement Mode MOSFET
Capacitance

Gate Charge

- V_{DS} - Drain-Source Voltage (V)
 Q_G - Gate Charge (nC)
Gate-Source On Resistance

Source-Drain Diode Forward

- V_{GS} - Gate - Source Voltage (V)
- V_{SD} - Source - Drain Voltage (V)
Drain-Source On Resistance

Gate Threshold Voltage


P-Channel Enhancement Mode MOSFET
DFN5×6 Package Outline Data

DIMENSIONS (unit : mm)

Symbol		Typ	Max	Symbol	Min	Typ	Max
A	0.90	1.02	1.10	D	4.90	4.98	5.10
D ₁	4.80	4.89	5.10	E	5.90	6.11	6.25
E ₁	5.65	5.74	5.95	e	3.72	3.80	3.92
e ₁	--	0.5	--	e ₂	--	1.	--
f	--	3.8	--	f ₁	0.31	0.37	0.51
f ₂	--	0.6	--	H	--	3.	--
H ₁	0.59	0.63	0.79	H ₂	0.26	0.28	0.32
L	3.35	3.45	3.65	L ₁	--	1.	--
v	--	0.1	--	w	0.64	0.68	0.84
y	--	0.3	--		--		--